



Maximum Rating

- Maximum input power: +10dBm (In Passband)
- Maximum DC Voltage : +/-5 V (Device only)
- Operating temperature: -30°C to +85°C
- Device storage temperature: -40°C to +100°C
- Moisture Sensitive Level: Level 1

Electrical Characteristics

Terminating source impedance: $Zs = 50 \Omega$ (Single-ended) Terminating load impedance: $Z_{L} = 100//18$ nH Ω (Balanced)

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Paramet	ters Description	Unit	Minimum	Typical	Maximum
	1574.42~1576.42 MHz	dB(*1)	-	1.5	1.9
Insertion Loss VSWR(Input/Output) Amplitude balance ((S21/S31)) Phase balance ((ΦS21-ΦS31)+180) Attenuation: 10~794 MHz 794~925 MHz 925~960 MHz	1565.42~1585.42 MHz	dB(*1)	-	1.6	2.0
	1597.5515~1605.8860 MHz	dB(*1)	-	1.7	Incal Maximum .5 1.9 .6 2.0 .7 2.1 .4 2.0 .5 2.0 .6 2.0 .5 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .6 2.0 .7 $+1.5$.6 $+1.8$ /+7 $+10$ /+7 $+10$ /+7 $+10$ /-8 $+15$.6 $-$.6 $-$.6 $-$.7 $-$.6 $-$.7 $-$.6 $-$.7 $-$.7 $-$.7 $-$.7 $-$.7 $-$ <
	1574.42~1576.42 MHz	-	-	1.4	2.0
Parameter Insertion Loss VSWR(Input/Output) Amplitude balance (([S21/S31])) Phase balance ((ΦS21-ΦS31)+180) Attenuation: 10~794 MHz 794~925 MHz 925~960 MHz 1427~1463 MHz 1710~1785 MHz 1850~1910 MHz 1920~1980 MHz 2401~2483 MHz	1565.42~1585.42 MHz	-	-	1.5	2.0
	1597.5515~1605.8860 MHz	-	-	1.6	2.0
	1574.42~1576.42 MHz		-1.5	+0.5/+0.7	+1.5
Amplitude balance ((S21/S31)) Phase balance ((ΦS21-ΦS31)+180)	1565.42~1585.42 MHz	dB	-5	-0.2/+2.7	+5
	1597.5515~1605.8860 MHz	dB	-1.8	+1/-0.6	+1.8
15 Phase balance ((ΦS21-ΦS31)+180) 15 15 15 15 15 15 15 15 15 15	1574.42~1576.42 MHz	deg	-10	+5/+7	+10
	1565.42~1585.42 MHz	deg	-10	-2/+7	+10
	1597.5515~1605.8860 MHz	deg	-15	-10/-8	+15
Attenuation:					
10~794 MHz		dB	45	50	-
794~925 MHz		dB	40	47	-
925~960 MHz		dB	40	46	-
1427~1463 MHz		dB	30	34	-
1710~1785 MHz		dB	35	42	-
1850~1910 MHz		dB	35	42	-
1920~1980 MHz		dB	34	39	-
2401~2483 MHz		dB	30	35	-
2500~2570 MHz		dB	30	34	-

(*1) Specification of insertion loss includes loss that comes from the test board. (0.1dB)

▲ CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

1. The design, manufacturing process, and specifications of this device are subject to change.

2. US or International patents may apply.

3. RoHS compliant from the first date of manufacture.





Frequency Characteristics













Outline Drawing

Device size: 1.1mmtyp. x 0.9mmtyp. x 0.5mmmax.



Unit: mm

Pin Configuration

Pin No.	Symbol	Function		
1	IN	Unbalanced pin		
2	GND	Ground		
3	OUT	Balanced pin		
4	OUT	Balanced pin		
5	GND	Ground		

Top View (Sample Production):



Top View (Mass Production):



Product date code (EIAJ)

Year	Jan,	Feb.	Mar.	Apr.	May.	Jun	Jul.	Aug.	Sep.	Oct.	Nov.	Dec.
2015	а	b	с	d	е	f	g	h	j	k	1	m
2016	n	р	q	r	s	t	u	v	w	x	у	z
2017	A	В	С	D	E	F	G	н	J	к	L	М
2018	N	Р	Q	R	S	Т	U	V	w	х	Y	z

Packing Reel Dimension



Materials of Reel

Material : Polystyrene + Carbon Characteristics : Conforms to EIAJ-ET-7200A Color : Black Surface resistance (reference value) : $10^{9}\Omega$ /sq Max.

Unit : mm

Code	Quantity	А	В	С	W1	W2
J	5,000 pcs	φ 180.0 + 0.0/-1.5	ф 66.0 +/-0 .5	¢ 13.0 +/-0.2	9.0 +1.0/-0.0	11.4 +/-1.0

Tape Dimension



The figure below shows the recommended temperature profile for reflow soldering in the case of lead-free solder alloy Sn3.0Ag0.5Cu.

Recommended number of reflow cycles is 5 maximum.

Suitable condition for solder heating is different depending on composition and manufacturing method. Please contact the solder manufacturer for details.

